

GENERAL DESCRIPTION

OB2281A is a highly integrated current mode PWM control IC optimized for high performance, low standby power and cost effective offline flyback converter applications.

PWM switching frequency at normal operation is internally fixed and is trimmed to tight range. At no load or light load condition, the IC operates in extended 'burst mode' to minimize switching loss. Lower standby power and higher conversion efficiency is thus achieved.

VCC low startup current and low operating current contribute to a reliable power on startup and low standby design with OB2281A.

OB2281A offers comprehensive protection coverage with auto-recovery including Cycle-by-Cycle current limiting (OCP), over load protection (OLP), VCC under voltage lockout (UVLO), over temperature protection (OTP), and over voltage protection (OVP). Excellent EMI performance is achieved with On-Bright proprietary frequency shuffling technique.

The tone energy at below 25KHz is minimized in the design and audio noise is eliminated during operation.

OB2281A is offered in SOT23-6 package.

APPLICATIONS

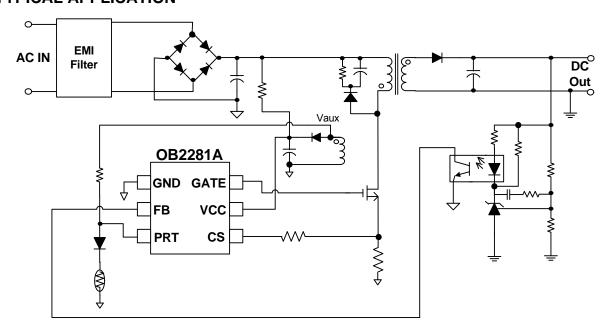
Offline AC/DC flyback converter for

- Printer, Storage power supply
- Power Adapter

FEATURES

- Power on soft start reducing MOSFET Vds stress
- Frequency shuffling for EMI
- Extended burst mode control for improved efficiency and low standby power design
- Audio noise free operation
- Over Load operation with increased frequency
- Comprehensive protection coverage
 - VCC Under Voltage Lockout with hysteresis (UVLO)
 - VCC Over Voltage Protection (VCC OVP)
 - Cycle-by-cycle over current threshold setting for constant output power limiting over universal input voltage range
 - Over Load Protection (OLP) with autorecovery
 - External (if NTC resistor is connected at PRT pin)or internal Over Temperature Protection (OTP)
 - Output Over Voltage Protection(Output OVP) and the OVP triggered voltage can be adjusted by the resistor connected between auxiliary winding and PRT pin
 - Output diode short protection with autorecovery

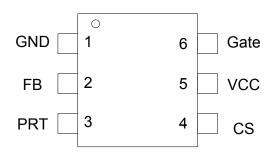
TYPICAL APPLICATION





GENERAL INFORMATION

Pin Configuration



Ordering Information

Part Number	Description			
OB2281AMP	SOT23-6, Pb-free in T&R			

Package Dissipation Rating

Package	RθJA(℃/W)
SOT23-6	200

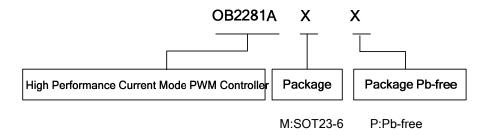
Recommended operating condition

Symbol	Parameter	Range
VCC	VCC Supply Voltage	12 to 26V

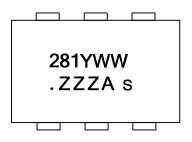
Absolute Maximum Ratings

Parameter	Value		
VCC DC Supply Voltage	V _{OVP} -1V		
FB Input Voltage	-0.3 to 7V		
CS Input Voltage	-0.3 to 7V		
PRT Input Voltage	-0.3 to 7V		
Min/Max Operating Junction Temperature TJ	-40 to 150 ℃		
Operating Ambient Temperature T _A	-40 to 85 ℃		
Min/Max Storage Temperature Tstg	-55 to 150 ℃		
Lead Temperature (Soldering, 10secs)	260 ℃		

Note: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum-rated conditions for extended periods may affect device reliability.



Marking Information



Y:Year Code

WW:Week Code(01-52)

ZZZ: Lot code A:Character Code S: Internal code

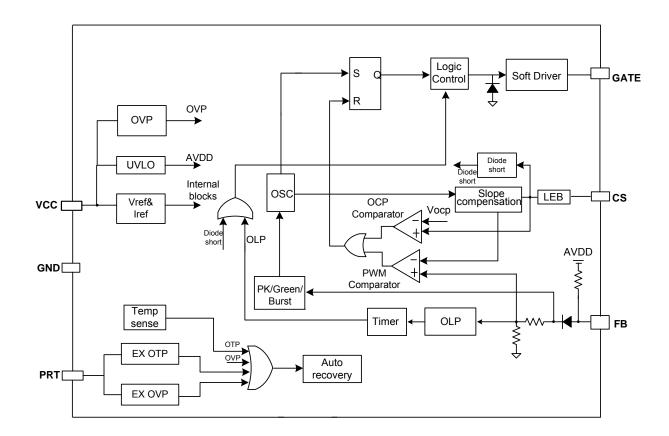


TERMINAL ASSIGNMENTS

Pin Name	1/0	Description
GND	Р	Ground
FB	I	Feedback input pin. The PWM duty cycle is determined by voltage level into this pin and the current-sense signal at Pin CS.
PRT	I	Dual functions pin. Connecting a NTC resistor to ground for OTP detection. Connecting a resistor from Vaux can adjust OVP trigger voltage. If both OTP and OVP are needed, a diode should be connected between PRT pin and the NTC resistor.
CS	I	Current sense input
VCC	Р	Power Supply
Gate	0	Totem-pole gate driver output for power MOSFET



FUNCTIONAL BLOCK DIAGRAM





ELECTRICAL CHARACTERISTICS

(T_A = 25[°]C, VCC=18V, unless otherwise noted)

Symbol	ol Parameter Test Conditions				Max	Unit
Supply Voltage (VD			Min	1.76.	max	, 0
Istartup	VCC: startup VCC Start up Current meas			2	5	uA
		current into VCC VDD=18V,CS=4V,				
I_VCC_Operation	Operation Current	FB=3.5V,measure I(VCC)		2.5	3	mA
I_VCC_Burst	Burst Current	CS=0V,FB=0.5V, measure I(VCC)		0.55	0.75	mA
UVLO(ON)	VCC Under Voltage Lockout Enter		6.5	7.3	8.1	V
UVLO(OFF)	VCC Under Voltage Lockout Exit (Recovery)		14.7	16.2	17.7	V
Vpull-up	Pull-up PMOS active			10		V
OVP	VCC Over Voltage Protection threshold voltage	FB=3V,CS=0V. Slowly ramp VCC, until no gate switching.	26.5	28	29.5	V
Feedback Input Sed	ction(FB Pin)					
V _{FB} Open	V _{FB} Open Loop Voltage			5.1		V
Avcs	PWM input gain ΔVFB/ΔVCS			3.5		V/V
Maximum duty cycle	Maximum duty Max duty cycle @			80	85	%
Vref_green	The threshold enter green mode			2.1		V
Vref_burst_H	The threshold exits burst mode			1.33		V
Vref_burst_L	The threshold enters burst mode			1.23		V
I _{FB} _Short	FB pin short circuit current	Short FB pin to GND and measure current		0.21		mA
V _{TH} _OLP	Open loop protection, FB Threshold Voltage			4.4		V
Td_OLP	Open loop protection, Debounce Time			15		ms
Z _{FB} _IN	Input Impedance			30		ΚΩ
Current Sense Inpu			T			
SST_CS	Soft start time for CS peak			4		ms
T_blanking	Leading edge blanking time			300		ns
Td_OC	Over Current Detection and Control Delay	From Over Current Occurs till the Gate driver output start to turn off		90		ns
V _{TH} _OC	Internal Current Limiting Threshold Voltage with zero duty cycle		0.43	0.45	0.47	V
V _{TH} _OC_Clamp				0.72		V
Td_OCP	Over Current protection debounce Time			60		ms
PRT pin						
IRT	Output current for external OTP		95	100	105	uA

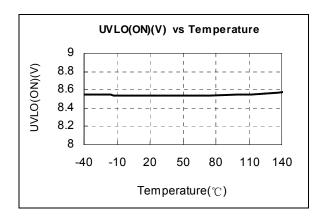


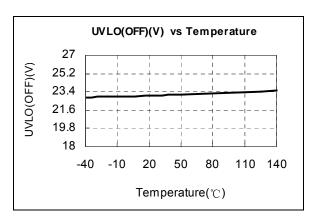
	detection					
VOTP	Threshold voltage for external OTP		0.95	1	1.05	V
loutput_ovp	Current threshold for adjustable output OVP			60		uA
Td_output_ovp	Output OVP debounce time			5		Cycles
In-chip OTP						
OTP enter				150		$^{\circ}$
OTP exit				120		$^{\circ}$
Oscillator		<u> </u>			4	_
Fosc	Normal Oscillation Frequency	VDD=18V,FB=3V, CS=0V	60	65	70	KHz
Fosc_PK	Peak frequency	VDD=18V,FB=4.5V, CS=0V		130		KHz
SST_freq	Soft start time of frequency			30		ms
∆f_OSC	f_OSC Frequency jittering			+/-6		%
F_shuffling	uffling Shuffling frequency			32		Hz
∆f_Temp	Frequency Temperature Stability			1		%
Δf_VCC Frequency Voltage Stability				1		%
F Burst	Burst Mode Switch Frequency			25		KHz
Gate driver				•	ı	
VOL	Output low level @ VDD=18V, lo=5mA				1	V
VOH	Output high level @ VCC=18V, Io=20mA	V, 6			V	
V_clamping	Output clamp voltage	11.5		11.5		V
T_r	Output rising time 1.2V ~ 10.8V @ CL=1000pF			100		ns
T_f	Output falling time 10.8V ~ 1.2V @ CL=1000pF			30		ns

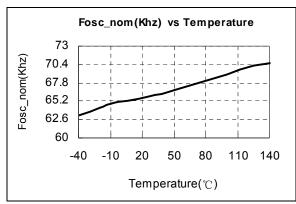


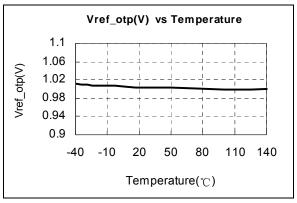
CHARACTERIZATION PLOTS

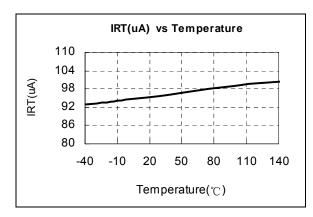
VDD = 18V, TA = 25℃ condition applies if not otherwise noted.

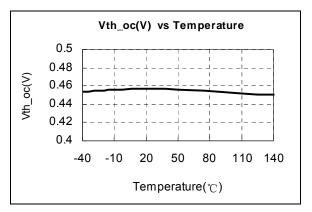


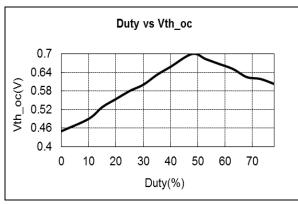














OPERATION DESCRIPTION

OB2281A is a highly integrated current mode PWM control IC optimized for high performance, low standby power and cost effective offline flyback converter applications. The 'extended burst mode' control greatly reduces the standby power consumption and helps the design easier to meet the international power conservation requirements.

Startup Current and Start up Control

Startup current of OB2281A is designed to be very low so that VCC could be charged up above UVLO threshold level and device starts up quickly. A large value startup resistor can therefore be used to minimize the power loss yet achieve a reliable startup in application.

Operating Current

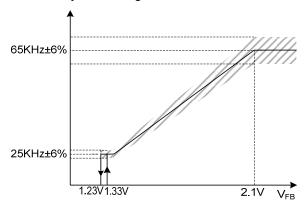
The Operating current of OB2281A is low at 2.5mA (typical). Good efficiency is achieved with OB2281A low operation current together with the 'extended burst mode' control features.

Soft Start

OB2281A features an internal 4ms (typical) soft start to soften the electrical stress occurring in the power supply during startup. It is activated during the power on sequence. As soon as VCC reaches UVLO(OFF), the CS peak voltage is gradually increased from 0.05V to the maximum level. Every restart up is followed by a soft start.

• Frequency shuffling for EMI improvement

The frequency shuffling (switching frequency modulation) is implemented in OB2281A. The oscillation frequency is modulated so that the tone energy is spread out. The spread spectrum minimizes the conduction band EMI and therefore eases the system design.



Extended Burst Mode Operation

At light load or no load condition, most of the power dissipation in a switching mode power

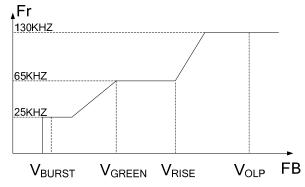
supply is from switching loss of the MOSFET, the core loss of the transformer and the loss of the snubber circuit. The magnitude of power loss is in proportion to the switching frequency. Lower switching frequency leads to the reduction on the power loss and thus conserves the energy.

The switching frequency is internally adjusted at no load or light load condition. The switch frequency reduces at light/no load condition to improve the conversion efficiency. At light load or no load condition, the FB input drops below Vref_burst_L (the threshold enter burst mode) and device enters Burst Mode control. The Gate drive output switches when FB input rises back to Vref_burst_H (the threshold exit burst mode). Otherwise the gate drive remains at off state to minimize the switching loss and reduces the standby power consumption to the greatest extend.

Oscillator Operation

During the full load power operation, OB2281A operates at a 65KHz (typical) fixed frequency. The efficiency and system cost is controlled at an optimal level. In over load mode, frequency is increased from 65KHz (typical) to 130KHz (typical).

At light load levels, OB2281A enters the light load mode, where the output current is reduced. The switching losses are reduced by lowering the switching frequency.



Current Sensing and Leading Edge Blanking

Cycle-by-Cycle current limiting is offered in OB2281A current mode PWM control. The switch current is detected by a sense resistor into the CS pin. An internal leading edge blanking circuit chops off the sensed voltage spike at initial internal power MOSFET on state due to snubber diode reverse recovery and surge gate current of power MOSFET. The current limiting comparator is disabled and cannot turn off the internal power MOSFET during the blanking period. The PWM



duty cycle is determined by the current sense input voltage and the FB input voltage.

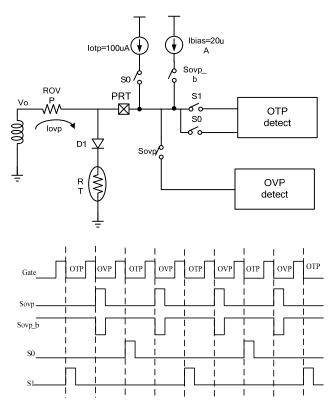
• Internal Synchronized Slope Compensation
Built-in slope compensation circuit adds voltage
ramp into the current sense input voltage for PWM
generation. This greatly improves the close loop
stability at CCM and prevents the sub-harmonic
oscillation and thus reduces the output ripple
voltage.

Driver

The power MOSFET is driven by a dedicated gate driver for power switch control. Too weak the gate driver strength results in higher conduction and switch loss of MOSFET while too strong gate driver strength results the compromise of EMI.

A good tradeoff is achieved through the built-in totem pole gate design with right output strength and dead time control. The low idle loss and good EMI system design is easier to achieve with this dedicated control scheme.

Dual Function of External OTP and Output OVP



On-Bright proprietary dual function of external OTP and output OVP provides feasible and accurate detection of external OTP through NTC resistor and output OVP. The dual function is realized through time-division technology as shown in the figure.

For external OTP detection, when switch control signal S1= "1", about 20uA (typical) current flows out from PRT pin. When switch control signal S0= "1",about 120uA (typical) current flows out from PRT pin. The PRT pin voltage difference \triangle Votp at phase S0 and S1 phase is equal to

$$\Delta V_{OTP} = \frac{RT \cdot ROVP}{ROVP + RT} \cdot 100 uA \cdot \label{eq:deltaVOTP}$$

When $\triangle Votp < 1V$, external OTP protection is triggered after 60 Gate cycles debounce.

For output OVP detection, when Sovp= "1", lovp is equal to Vo/ROVP. If lovp is larger than 60uA (typical), OVP protection is triggered after 5 Gate cycles debounce. By selecting proper Rovp resistance, output OVP level can be programmed.

$$\frac{Vout * \frac{Naux}{Nout} - 0.15V}{\frac{Rovp}{}} \ge 60uA$$

Vout: output voltage

Nout: the secondary winding turns Naux: the auxiliary winding turns

Protection Controls

Good power supply system reliability is achieved with auto-recovery protection features including Cycle-by-Cycle current limiting (OCP), Under Voltage Lockout on VDD (UVLO), Over Temperature Protection (OTP), VCC and output Over Voltage Protection (OVP).

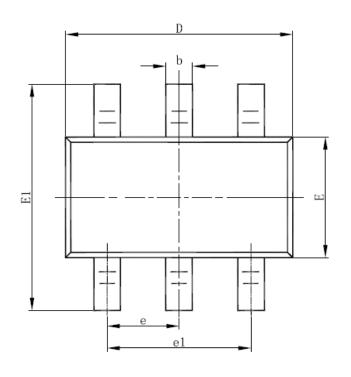
With On-Bright proprietary technology, the OCP is line voltage compensated to achieve constant output power limit over the universal input voltage range.

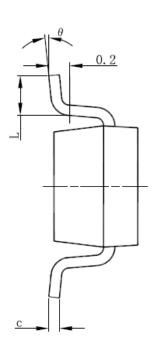
At overload condition when FB input voltage exceeds power limit threshold value for more than Td_OLP, control circuit reacts to shut down the converter. It restarts when VDD voltage drops below UVLO limit.

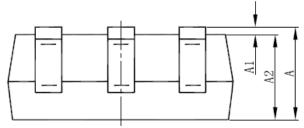


PACKAGE MECHANICAL DATA

SOT-23-6L PACKAGE OUTLINE DIMENSIONS







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.000	1.450	0.039	0.057	
A1	0.000	0.150	0.000	0.006	
A2	0.900	1.300	0.035	0.051	
b	0.300	0.500	0.012	0.020	
С	0.080	0.220	0.003	0.009	
D	2.800	3.020	0.110	0.119	
E	1.500	1.726	0.059	0.068	
E1	2.600	3.000	0.102	0.118	
е	0.950 (F	BSC)	0.037 (BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



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